



# N-Channel 40-V (D-S), 175 °C MOSFET

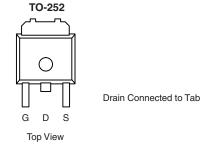
PRODUCT SUMMARY					
V <sub>(BR)DSS</sub> (V)	$r_{DS(on)}\left(\Omega\right)$	I <sub>D</sub> (A) <sup>c</sup>	Q <sub>g</sub> (Typ)		
40	0.009 at V <sub>GS</sub> = 10 V	50	55		

### **FEATURES**

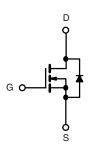
- TrenchFET® Power MOSFETS
- 175 °C Junction Temperature
- High Threshold Voltage At High Temperature



ROHS



Ordering Information: SUD50N04-09H-E3 (Lead (Pb)-free)



N-Channel MOSFET

ABSOLUTE MAXIMUM RATINGS $T_A =$	= 25 °C, unless othe	rwise noted			
Parameter		Symbol	Limit	Unit	
Drain-Source Voltage		V <sub>DS</sub>	40	V	
Gate-Source Voltage		V <sub>GS</sub> ± 20		v	
Continuous Drain Current (T <sub>.I</sub> = 175 °C)	T <sub>C</sub> = 25 °C		50 <sup>c</sup>		
Continuous Diam Curient (1) = 175 C)	T <sub>C</sub> = 100 °C	l I <sub>D</sub>	48 <sup>c</sup>	A	
Pulsed Drain Current		I <sub>DM</sub>	100	1 ^	
Avalanche Current		I <sub>AS</sub>	35	1	
Single Avalanche Energy <sup>a</sup>	L = 0.1 mH	E <sub>AS</sub>	61.25	mJ	
Power Dissipation	T <sub>C</sub> = 25 °C	P <sub>D</sub>	83.3	W	
Operating Junction and Storage Temperature Range		T <sub>J</sub> , T <sub>stg</sub>	- 55 to 175	°C	

THERMAL RESISTANCE RATINGS					
Parameter		Symbol	Typical	Maximum	Unit
horsting to Austrianth	t ≤ 10 sec	R <sub>thJA</sub>	18	22	°C/W
Junction-to-Ambient <sup>b</sup>	Steady State		40	50	
Junction-to-Case		R <sub>thJC</sub>	1.5	1.8	

#### Notes:

- a. Duty cycle  $\leq$  1 %.
- b. Surface Mounted on 1" FR4 board.
- c. Based on maximum allowable Junction Temperature. Package limitation current is 50 A.

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## SUD50N04-09H

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<b>SPECIFICATIONS</b> $T_J = 25$ Parameter	Symbol	Test Conditions	Min	Тур	Max	Unit	
Static	Зуппоп	Test conditions	IVIIII	Тур	IVIAA	Offic	
Drain-Source Breakdown Voltage	V <sub>(BR)DSS</sub>	V <sub>GS</sub> = 0 V, I <sub>D</sub> = 250 μA	40	1			
Gate Threshold Voltage	V <sub>GS(th)</sub>	$V_{DS} = V_{GS}, I_D = 250 \mu\text{A}$	3.4		5.0	V	
Gate-Body Leakage	I <sub>GSS</sub>	$V_{DS} = 0 \text{ V}, V_{GS} = \pm 20 \text{ V}$	0.1		± 100	nA	
Zero Gate Voltage Drain Current	433	$V_{DS} = 40 \text{ V}, V_{GS} = 0 \text{ V}$			1		
	I <sub>DSS</sub>	V <sub>DS</sub> = 40 V, V <sub>GS</sub> = 0 V, T <sub>J</sub> = 125 °C			50	μΑ	
	D00	V <sub>DS</sub> = 40 V, V <sub>GS</sub> = 0 V, T <sub>J</sub> = 175 °C			150		
On-State Drain Current <sup>a</sup>	I <sub>D(on)</sub>	V <sub>DS</sub> = 5 V, V <sub>GS</sub> = 10 V	50			Α	
Drain-Source On-State Resistance <sup>a</sup>	D(OII)	V <sub>GS</sub> = 10 V, I <sub>D</sub> = 20 A		0.0072	0.009	Ω	
	r <sub>DS(on)</sub>	V <sub>GS</sub> = 10 V, I <sub>D</sub> = 20 A, T <sub>J</sub> = 125 °C			0.014		
		V <sub>GS</sub> = 10 V, I <sub>D</sub> = 20 A, T <sub>J</sub> = 175 °C			0.018		
Forward Transconductance <sup>a</sup>	9 <sub>fs</sub>	V <sub>DS</sub> = 15 V, I <sub>D</sub> = 15 A	20	57		S	
Dynamic <sup>b</sup>							
Input Capacitance	C <sub>iss</sub>			3700		pF	
Output Capacitance	C <sub>oss</sub>	V <sub>GS</sub> = 0 V, V <sub>DS</sub> = 25 V, f = 1 MHz		340			
Reverse Transfer Capacitance	C <sub>rss</sub>			175			
Total Gate Charge <sup>c</sup>	Qg			55	85		
Gate-Source Charge <sup>c</sup>	Q <sub>gs</sub>	$V_{DS} = 20 \text{ V}, V_{GS} = 10 \text{ V}, I_{D} = 50 \text{ A}$		19		nC	
Gate-Drain Charge <sup>c</sup>	Q <sub>qd</sub>			13			
Gate Resistance	R <sub>g</sub>			1.3		Ω	
Turn-On Delay Time <sup>c</sup>	t <sub>d(on)</sub>			12	20		
Rise Time <sup>c</sup>	t <sub>r</sub>	$V_{DD} = 20 \text{ V}, R_{L} = 0.4 \Omega$ $I_{D} \cong 50 \text{ A}, V_{GEN} = 10 \text{ V}, R_{q} = 2.5 \Omega$		20	30	ns	
Turn-Off Delay Time <sup>c</sup>	t <sub>d(off)</sub>			35	55		
Fall Time <sup>c</sup>	t <sub>f</sub>	<u>,</u>		11	20		
Source-Drain Diode Ratings and Cha	aracteristics	(T <sub>C</sub> = 25 °C) <sup>b</sup>		1			
Continuous Current	Is				50		
Pulsed Current	I <sub>SM</sub>				100	Α	
Forward Voltage <sup>a</sup>	V <sub>SD</sub>	$I_F = 30 \text{ A}, V_{GS} = 0 \text{ V}$		0.90	1.50	V	
Reverse Recovery Time	t <sub>rr</sub>	I <sub>F</sub> = 30 A, di/dt = 100 A/μs		30	45	ns	

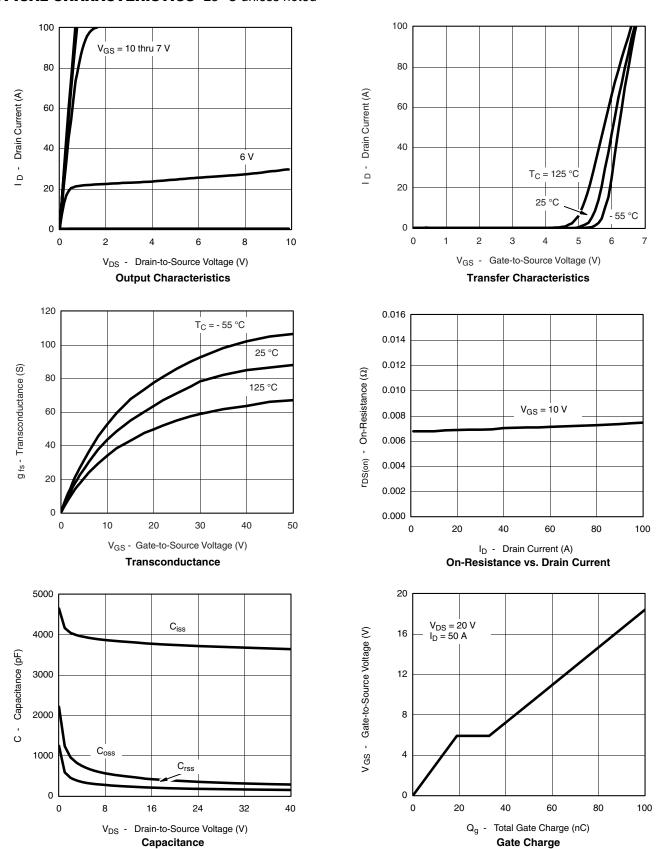
### Notes:

- a. Pulse test; pulse width  $\leq 300~\mu s,$  duty cycle  $\leq 2~\%.$
- b. Guaranteed by design, not subject to production testing.
- c. Independent of operating temperature.

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.



## TYPICAL CHARACTERISTICS 25 °C unless noted

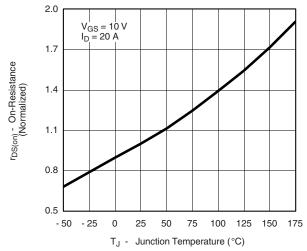


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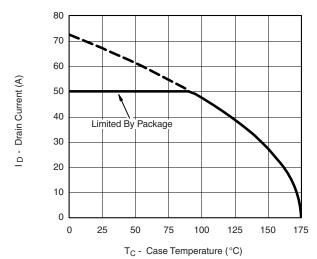
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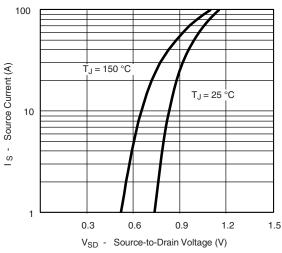


On-Resistance vs. Junction Temperature

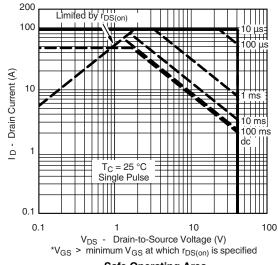
## THERMAL RATINGS



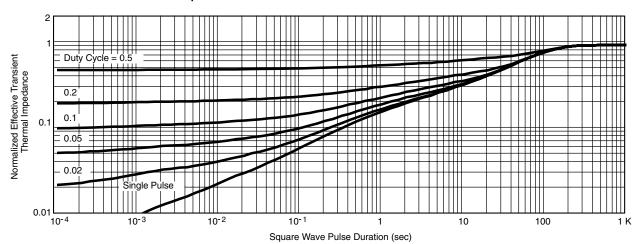
# Maximum Avalanche and Drain Current vs. Case Temperature



Source-Drain Diode Forward Voltage



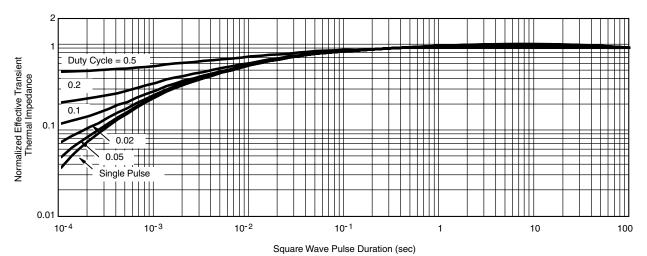
Safe Operating Area



Normalized Thermal Transient Impedance, Junction-to-Ambient



### THERMAL RATINGS



Normalized Thermal Transient Impedance, Junction-to-Case

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